

# N-Channel 60 V(D-S) MOSFET

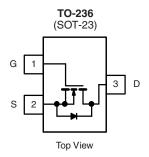
PRODUC	T SUMMARY	
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)
60	0.91 at V <sub>GS</sub> = 10 V	0.7

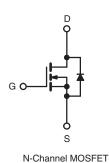
#### **FEATURES**

Halogen-free According to IEC 61249-2-21



- 100 % R<sub>g</sub> and UIS Tested
  Trench Power MOSFET
- Compliant to RoHS Directive 2002/95/EC





ABSOLUTE MAXIMUM RATINGS (	$\Gamma_A = 25  ^{\circ}\text{C}$ , unle	ess otherwise	noted)		
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	(	60	V
Gate-Source Voltage		V <sub>GS</sub>	± 20		V
Continuous Drain Current (T <sub>.I</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C		0.7	0.48	
Continuous Diam Current (1 <sub>J</sub> = 150 °C)	T <sub>A</sub> = 70 °C	l <sub>D</sub>	0.55	0.36	^
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	3.0		Α
Avalanche Current <sup>b</sup>	L = 0.1 mH	I <sub>AS</sub>	3	3.0	
Single Avalanche Energy	L = 0.1 IIII	E <sub>AS</sub>		50	mJ
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>		0.7	Α
Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	В	1.55	1.03	W
rower Dissipation	T <sub>A</sub> = 70 °C	P <sub>D</sub>	1.20	0.87	VV
Operating Junction and Storage Temperature Range	е	T <sub>J</sub> , T <sub>stg</sub>	- 55	to 150	°C

THERMAL RESISTANCE RATING	S				
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 5 s	В	80	100	
Maximum Junction-to-Ambient	Steady State	R <sub>thJA</sub>	130	170	°C/W
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	45	55	

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. Pulse width limited by maximum junction temperature.

服务热线:400-655-8788

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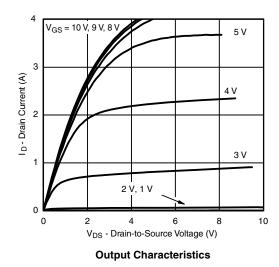
			Limits			
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	60			V
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1.0		2.5	V
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 20 V			± 100	nA
Zava Cata Valtaga Dvain Current		V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V			1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C			75	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 15 \text{ V}, V_{GS} = 10 \text{ V}$	2.5			Α
Drain-Source On-Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 A		0.91		Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 0.5 A		4		S
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V		0.8	1.2	V
Dynamic <sup>b</sup>						
Total Gate Charge	Qg			3		nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 0.5 \text{ A}$		0.37		
Gate-Drain Charge	Q <sub>gd</sub>			1.45		
Gate Resistance	R <sub>g</sub>		0.5	1.3	2.4	Ω
Switching						
Turn-On Delay Time	t <sub>d(on)</sub>			7	11	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, $R_L$ = 33 $\Omega$		10	15	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 0.2 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		9	15	ns
Fall Time	t <sub>f</sub>			11	15	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 0.5 A, dI/dt = 100 A/μs50100				

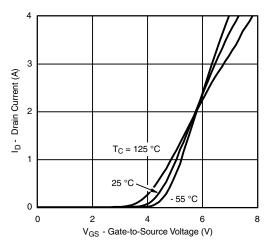
#### Notes:

- a. Pulse test: PW  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

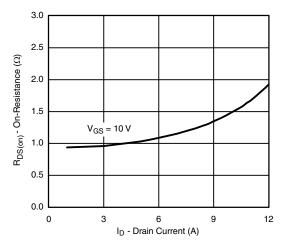




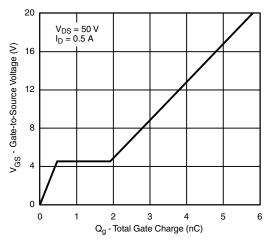
**Transfer Characteristics** 



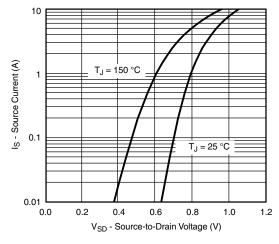
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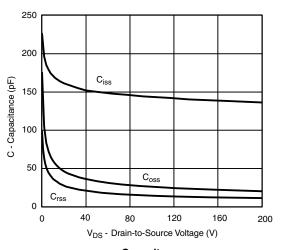
#### On-Resistance vs. Drain Current



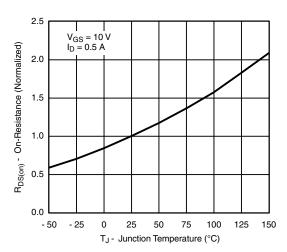
**Gate Charge** 



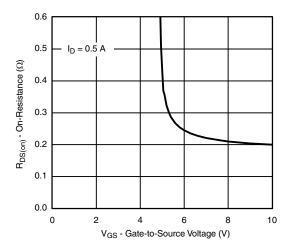
Source-Drain Diode Forward Voltage



Capacitance



On-Resistance vs. Junction Temperature

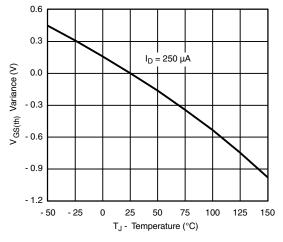


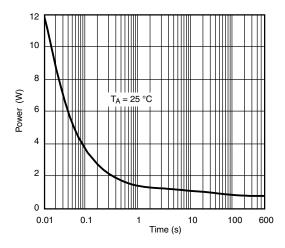
On-Resistance vs. Gate-to-Source Voltage

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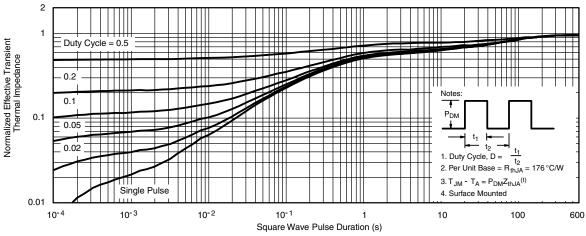
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





**Threshold Voltage** 

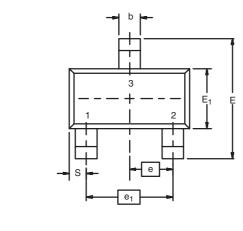


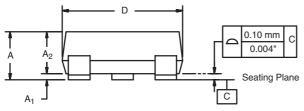


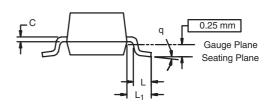
Normalized Thermal Transient Impedance, Junction-to-Ambient



# SOT-23 (TO-236): 3-LEAD







Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
Α	0.89	1.12	0.035	0.044
A <sub>1</sub>	0.01	0.10	0.0004	0.004
A <sub>2</sub>	0.88	1.02	0.0346	0.040
b	0.35	0.50	0.014	0.020
С	0.085	0.18	0.003	0.007
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.083	0.104
E <sub>1</sub>	1.20	1.40	0.047	0.055
е	0.95 BSC		0.0374	4 Ref
e <sub>1</sub>	1.90 BSC		0.074	8 Ref
L	0.40	0.60	0.016	0.024
L <sub>1</sub>	0.64 Ref		0.025	Ref
S	0.50 Ref		0.020	) Ref
q	3°	8°	3°	8°

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479



## **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)



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